

### 20V N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON) max</sub>	Package	I <sub>D max</sub> T <sub>A</sub> = +25°C
20V	11.6mΩ @ V <sub>GS</sub> = 4.5V	U-DFN2020-6	10.5A
200	15mΩ @ V <sub>GS</sub> = 2.5V	Type E	9.4A

### **Description**

This new generation MOSFET has been designed to minimize the onstate resistance (R<sub>DS(on)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

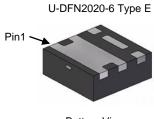
- General Purpose Interfacing Switch
- **Power Management Functions**

### **Features**

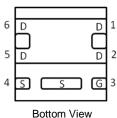
- 0.6mm profile ideal for low profile applications
- PCB footprint of 4mm<sup>2</sup>
- Low Gate Threshold Voltage
- Low On-Resistance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

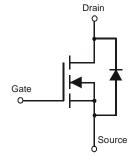
- Case: U-DFN2020-6 Type E
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0065 grams (approximate)







Pin Out



**Equivalent Circuit** 

### Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Quantity per reel
DMN2015UFDE-7	N4	7	3,000
DMN2015UFDE-13	N4	13	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



N4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date Code Key

Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Υ		Z		Α		3	С		D		Е
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V <sub>DSS</sub>	20	V		
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
Continuous Dusin Courset (Nata CVV)	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	10.5 8.5	А	
Continuous Drain Current (Note 6) V <sub>GS</sub> = 4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	12.5 10.0	А
Continuous Dusin Courset (Note CVV	I <sub>D</sub>	9.4 7.5	А		
Continuous Drain Current (Note 6) V <sub>GS</sub> = 2.5V	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	11.2 8.8	А	
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I <sub>DM</sub>	80	А		
Maximum Body Diode Continuous Current	Is	2.5	Α		

### **Thermal Characteristics**

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	D	0.66	W
Total Power Dissipation (Note 5)	T <sub>A</sub> = +70°C	P <sub>D</sub>	0.42	
Thormal Posistance Junction to Ambient (Note 5)	Steady state	D	189	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	132	
Total Power Dissipation (Note 6)	$T_A = +25$ °C	Б	2.03	W
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	$P_{D}$	1.31	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	D	61	°C/W
mermai Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	43	
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	9.3	
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

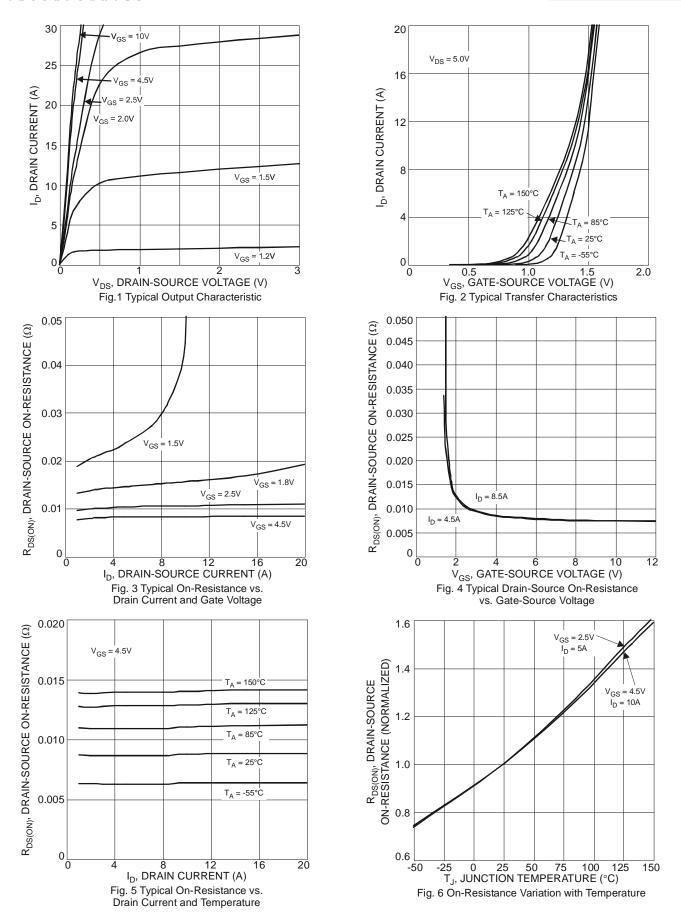
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 7)								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	I	_	٧	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	$I_{DSS}$		1	1	μА	$V_{DS} = 16V, V_{GS} = 0V$		
Gate-Source Leakage	I <sub>GSS</sub>	1	-	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 7)								
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.5	_	1.1	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$		
			9.3	11.6		$V_{GS} = 4.5V, I_D = 8.5A$		
Static Drain-Source On-Resistance	D	_	11.4	15	mΩ	$V_{GS} = 2.5V, I_D = 8.5A$		
Static Drain-Source On-Nesistance	R <sub>DS (ON)</sub>		17	30	11122	$V_{GS} = 1.8V, I_D = 5A$		
			24	50		$V_{GS} = 1.5V, I_D = 3A$		
Forward Transfer Admittance	Y <sub>fs</sub>		11.3	_	S	$V_{DS} = 10V, I_D = 8.5A$		
Diode Forward Voltage	$V_{SD}$		-	1.2	V	$V_{GS} = 0V, I_{S} = 8.5A$		
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance	C <sub>iss</sub>	1	1779	_	pF	101/11/101/		
Output Capacitance	Coss		175	_	рF	$V_{DS} = 10V, V_{GS} = 0V,$ -f = 1.0MHz		
Reverse Transfer Capacitance	C <sub>rss</sub>		154	_	pF	1 – 1.001112		
Gate Resistance	$R_{g}$		0.94	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$		
Total Gate Charge (V <sub>GS</sub> = 4.5V)	$Q_{g}$	1	19.7	_	nC			
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_g$	l	45.6	_	nC	V <sub>DS</sub> = 10V. I <sub>D</sub> = 8.5A		
Gate-Source Charge	$Q_{gs}$	I	2.9		nC	$V_{DS} = 10V$ , $I_D = 6.5A$		
Gate-Drain Charge	$Q_{gd}$	-	3.8	_	nC			
Turn-On Delay Time	t <sub>D(on)</sub>	_	7.4	_	ns			
Turn-On Rise Time	t <sub>r</sub>	_	16.8	_	ns	$V_{DS} = 10V, I_D = 8.5A$		
Turn-Off Delay Time	t <sub>D(off)</sub>	-	43.6	_	ns	$V_{GS} = 4.5V, R_G = 1.8\Omega$		
Turn-Off Fall Time	t <sub>f</sub>	_	10.9	_	ns			
Reverse Recovery Time	$T_{rr}$	_	8.6	_	ns	1 0 5 A di/dt 040 A /		
Reverse Recovery Charge	Q <sub>rr</sub>	_	3.7	_	nC	I <sub>F</sub> = 8.5A, di/dt = 210A/μs		

Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.

<sup>8.</sup> Guaranteed by design. Not subject to production testing.







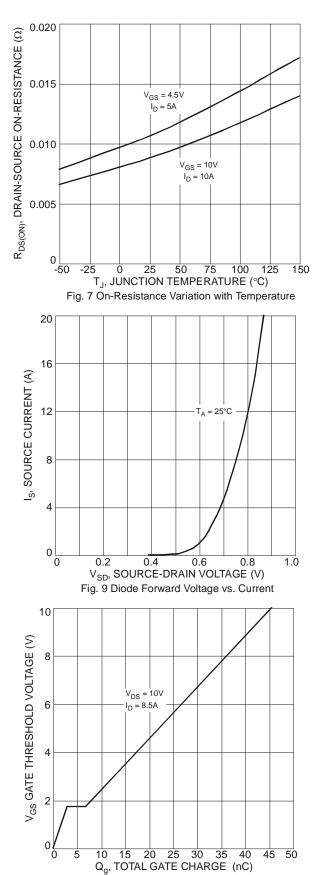


Fig. 11 Gate Charge

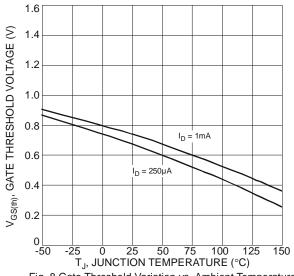
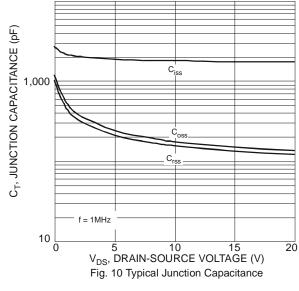
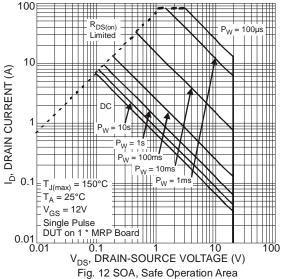
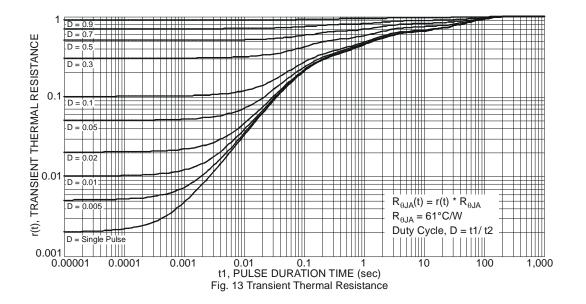


Fig. 8 Gate Threshold Variation vs. Ambient Temperature

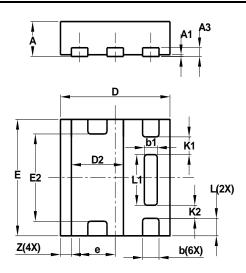






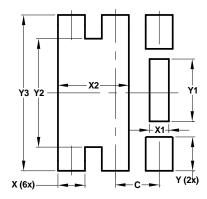


## **Package Outline Dimensions**



U-DFN2020-6 Type E							
Dim Min Max Typ							
Α	0.57	0.63	0.60				
A1	0	0.05	0.03				
A3	_	_	0.15				
b	0.25	0.35	0.30				
b1	0.185	0.285	0.235				
D	1.95	2.05	2.00				
D2	0.85	1.05	0.95				
E	1.95	2.05	2.00				
E2	1.40	1.60	1.50				
е	_	_	0.65				
L	0.25	0.35	0.30				
L1	0.82	0.92	0.87				
K1	_	_	0.305				
K2	_	_	0.225				
Z	_	_	0.20				
All Dimensions in mm							

# **Suggested Pad Layout**



Dimensions	Value
Difficusions	(in mm)
С	0.650
X	0.400
X1	0.285
X2	1.050
Y	0.500
Y1	0.920
Y2	1.600
Y3	2.300



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